

Silicon Carbide (SiC) Schottky Diode - EliteSiC, 20 A, 650 V, D2, TO-220-2L

FFSP2065B

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 94 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuit

ABSOLUTE MAXIMUM RATINGS

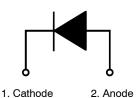
(T_C = 25°C, Unless otherwise specified)

Symbol	Parame	Value	Unit	
V_{RRM}	Peak Repetitive Revers	650	V	
E _{AS}	Single Pulse Avalanche	94	mJ	
I _F	Continuous Rectified Fo	20	Α	
	Continuous Rectified For $T_C < 135^{\circ}C$	22.5		
I _{F, Max}	Non-Repetitive Peak	$T_C = 25^{\circ}C$, 10 µs	882	Α
	Forward Surge Current	T _C = 150°C, 10 μs	798	
I _{F, SM}	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	84	Α
P _{tot}	Power Dissipation	T _C = 25°C	150	W
		T _C = 150°C	25	
T _J , T _{STG}	Operating and Storage	-55 to +175	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

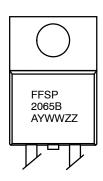
1. E_{AS} of 94 mJ is based on starting $T_J = 25^{\circ}C$, L = 0.5 mH, $I_{AS} = 19.4$ A, V = 50 V.

ELECTRICAL CONNECTION





MARKING DIAGRAM



FFSP2065B = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

FFSP2065B

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	1.0	°C/W

ELECTRICAL CHARACTERISTICS $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions Min.		Тур.	Max.	Unit
V_{F}	Forward Voltage	$I_F = 20 \text{ A}, T_C = 25^{\circ}\text{C}$ – 1.38		1.38	1.7	V
		I _F = 20 A, T _C = 125°C	-	1.6	2.0	
		I _F = 20 A, T _C = 175°C	ı	1.72	2.4	
I _R	Reverse Current	$V_R = 650 \text{ V}, T_C = 25^{\circ}\text{C}$	-	0.5	40	μΑ
		V _R = 650 V, T _C = 125°C	-	1	80	
		V _R = 650 V, T _C = 175°C	-	2	160	
$Q_{\mathbb{C}}$	Total Capacitive Charge	V = 400 V	-	51	-	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	866	-	pF
		V _R = 200 V, f = 100 kHz	-	80	-	
		V _R = 400 V, f = 100 kHz	-	70	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFSP2065B	FFSP2065B	TO-220-2L	Tube	N/A	N/A	50 Units

TYPICAL CHARACTERISTICS TJ = 25°C UNLESS OTHERWISE NOTED

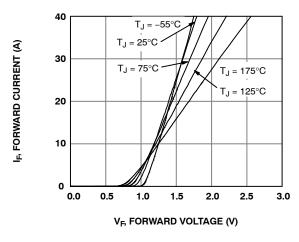


Figure 1. Forward Characteristics

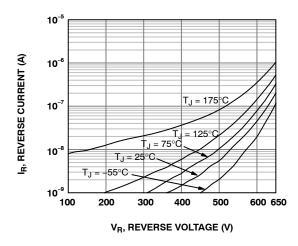


Figure 2. Reverse Characteristics

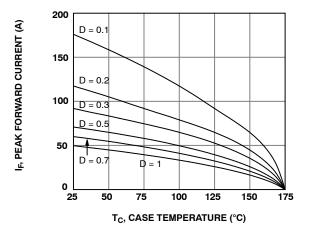


Figure 3. Current Derating

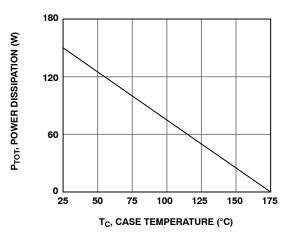


Figure 4. Power Dissipation

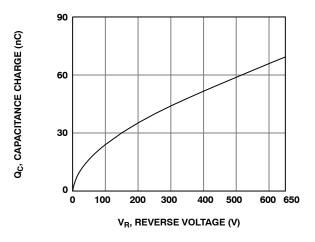


Figure 5. Capacitance Charge vs. Reverse Voltage

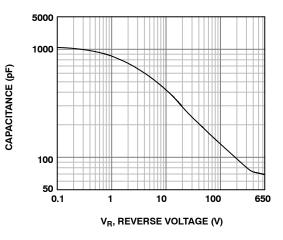


Figure 6. Capacitance vs. Reverse Voltage

FFSP2065B

TYPICAL CHARACTERISTICS T_J = 25°C UNLESS OTHERWISE NOTED (CONTINUED)

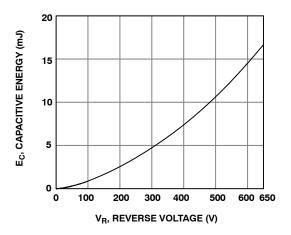


Figure 7. Capacitance Stored Energy

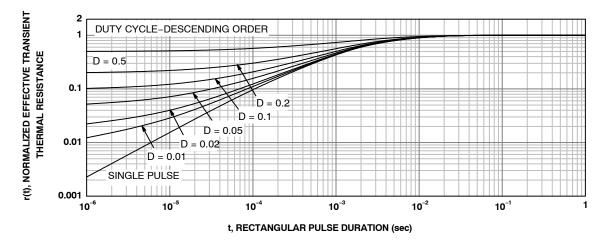


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

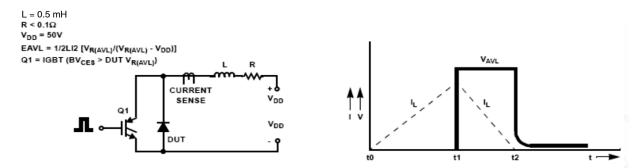
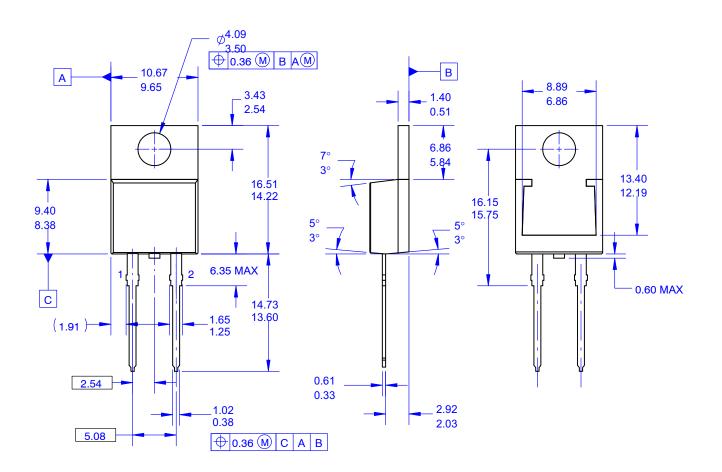


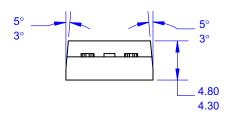
Figure 9. Unclamped Inductive Switching Test Circuit & Waveform



TO-220-2LD CASE 340BB ISSUE O

DATE 31 AUG 2016





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220,ISSUE K, VARIATION AC,DATED APRIL 2002.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5–2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

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